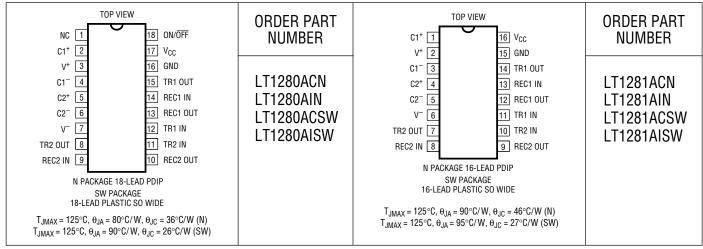
ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage (V _{CC}) V ⁺ V ⁻	13.2V
	– 15.2 V
Input Voltage	
Driver	V ⁻ to V ⁺
Receiver	
0N/0FF	0.3V to 12V
Output Voltage	
Driver	
Receiver	0.3V to V_{CC} + 0.3V

Short-Circuit Duration	
V+	30 sec
V ⁻	30 sec
Driver Output	Indefinite
Receiver Output	Indefinite
Operating Temperature Range	
LT1280AC/LT1281AC	0°C to 70°C
LT1280AI/LT1281AI	40°C to 85°C
Storage Temperature Range	. −65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION



Consult factory for Military grade parts.

ELECTRICAL CHARACTERISTICS (Note 2)

PARAMETER	CONDITIONS			MIN	TYP	MAX	UNITS
Power Supply Generator							
V ⁺ Output					7.9		V
V ⁻ Output					-7.0		V
Supply Current (V _{CC})	(Note 3), T _A = 25°C		•		8	10 14	mA mA
Supply Current When OFF (V _{CC})	Shutdown (Note 4) LT1280A Only		•		1	10	μA
Supply Rise Time Shutdown to Turn-On	C1 = C2 = C3 = C4 = 0.1µF LT1280A Only				0.2 0.2		ms ms
ON/OFF Pin Thresholds	Input Low Level (Device Shutdown) Input High Level (Device Enabled)		•	0.8	1.2 1.6	2.4	V V
ON/OFF Pin Current	$0V \le V_{ON/OFF} \le 5V$			-15		80	μA
Oscillator Frequency					130		kHz
Driver							
Output Voltage Swing	Load = 3k to GND	Positive Negative	•	5.0	7.5 -6.3	-5.0	V V
Logic Input Voltage Level	Input Low Level (V _{OUT} = High) Input High Level (V _{OUT} = Low)		•	2.0	1.4 1.4	0.8	V V



ELECTRICAL CHARACTERISTICS (Note 2)

PARAMETER	CONDITIONS			MIN	ТҮР	MAX	UNITS
Logic Input Current	$0.8V \le V_{IN} \le 2.0V$		•		5	20	μA
Output Short-Circuit Current	V _{OUT} = 0V			±9	17		mA
Output Leakage Current	Shutdown $V_{OUT} = \pm 30V$ (Note 4)		•		10	100	μA
Data Rate (Note 7)	$ \begin{array}{l} R_L = 3k, \ C_L = 2500 p F \\ R_L = 3k, \ C_L = 1000 p F \end{array} $			120 250			kBaud kBaud
Slew Rate	$R_L = 3k, C_L = 51pF$ $R_L = 3k, C_L = 2500pF$			4	15 7	30	V/µs V/µs
Propagation Delay	Output Transition t _{HL} High-to-Low (Note 5) Output Transition t _{LH} Low-to-High				0.6 0.5	1.3 1.3	μs μs
Receiver							
Input Voltage Thresholds	Input Low Threshold (V _{OUT} = High) Input High Threshold (V _{OUT} = Low)	C Grade C Grade	•	0.8	1.3 1.7	2.4	V V
	Input Low Input High	l Grade I Grade	•	0.2	1.3 1.7	3.0	V V
Hysteresis			•	0.1	0.4	1.0	V
Input Resistance	$V_{IN} = \pm 10V$			3	5	7	kΩ
Output Leakage Current	Shutdown (Note 4) $0 \le V_{OUT} \le V_{CC}$		•		1	10	μA
Output Voltage	Output Low, I _{OUT} = -1.6mA Output High, I _{OUT} = 160µA (V _{CC} = 5V)		•	3.5	0.2 4.2	0.4	V V
Output Short-Circuit Current	Sinking Current, V _{OUT} = V _{CC} Sourcing Current, V _{OUT} = 0V			10	-20 20	-10	mA mA
Propagation Delay	Output Transition t _{HL} High-to-Low (Note 6) Output Transition t _{LH} Low-to-High				250 350	600 600	ns ns

The \bullet denotes specifications which apply over the operating temperature range (0°C \leq T_A \leq 70°C for commercial grade, and -40°C \leq T_A \leq 85°C for industrial grade.

Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

Note 2: Testing done at $V_{CC} = 5V$ and $V_{ON/\overline{OFF}} = 3V$, unless otherwise specified.

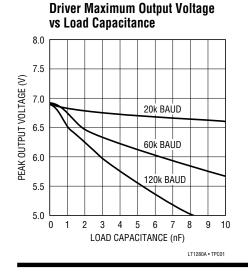
Note 3: Supply current is measured as the average over several charge pump cycles. $C^+ = C^- = C1 = C2 = 0.1 \mu F$. All outputs are open, with all driver inputs tied high.

Note 4: Supply current measurements in shutdown are performed with $V_{ON/OFF} \leq 0.1V$.

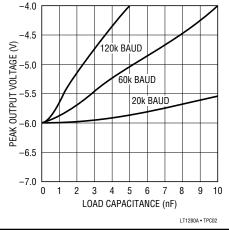
Note 5: For driver delay measurements, $R_L = 3k$ and $C_L = 51pF$. Trigger points are set between the driver's input logic threshold and the output transition to the zero crossing ($t_{HL} = 1.4V$ to 0V and $t_{LH} = 1.4V$ to 0V). **Note 6:** For receiver delay measurements, $C_L = 51pF$. Trigger points are set between the receiver's input logic threshold and the output transition to standard TTL/CMOS logic threshold ($t_{HL} = 1.3V$ to 2.4V and $t_{LH} = 1.7V$ to 0.8V).

Note 7: Data rate operation guaranteed by slew rate, short-circuit current and propagation delay tests.

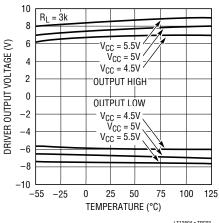
TYPICAL PERFORMANCE CHARACTERISTICS



Driver Minimum Output Voltage vs Load Capacitance



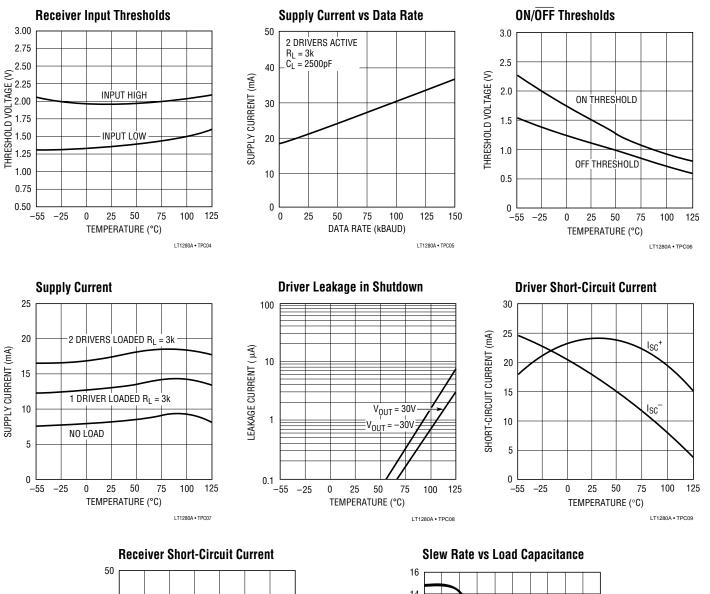
Driver Output Voltage

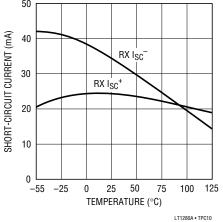


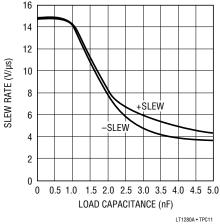
LT1280A • TPC03



TYPICAL PERFORMANCE CHARACTERISTICS

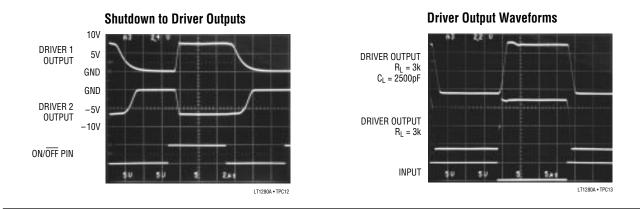








TYPICAL PERFORMANCE CHARACTERISTICS



PIN FUNCTIONS

 V_{CC} : 5V Input Supply Pin. This pin should be decoupled with a 0.1µF ceramic capacitor close to the package pin. Insufficient supply bypassing can result in low output drive levels and erratic charge pump operation.

GND: Ground Pin.

ON/OFF: A TTL/CMOS Compatible Operating Mode Control. A logic low puts the LT1280A in shutdown mode. Supply current drops to zero and both driver and receiver outputs assume a high impedance state. A logic high fully enables the device.

 V^+ : Positive Supply Output (RS232 Drivers). $V^+\approx 2V_{CC}-1.5V$. This pin requires an external charge storage capacitor C $\geq 0.1 \mu F$, tied to ground or V_{CC}. Larger value capacitors may be used to reduce supply ripple. With multiple transceivers, the V⁺ and V⁻ pins may be paralleled into common capacitors.

V⁻: Negative Supply Output (RS232 Drivers). V⁻ \approx - (2V_{CC}-2.5V). This pin requires an external charge storage capacitor C \geq 0.1µF. Larger value capacitors may be used to reduce supply ripple. With multiple transceivers, the V⁺ and V⁻ pins may be paralleled into common capacitors.

TR1 IN, TR2 IN: RS232 Driver Input Pins. These inputs are TTL/CMOS compatible. Inputs should not be allowed to float. Tie unused inputs to V_{CC} .

TR1 OUT, TR2 OUT: Driver Outputs at RS232 Voltage Levels. Driver output swing meets RS232 levels for loads up to 3k. Slew rates are controlled for lightly loaded lines.

Output current capability is sufficient for load conditions up to 2500pF. Outputs are in a high impedance state when in shutdown mode or $V_{CC} = 0V$. Outputs are fully shortcircuit protected from $V^- + 30V$ to $V^+ - 30V$. Applying higher voltages will not damage the device if the overdrive is moderately current limited. Short circuits on one output can load the power supply generator and may disrupt the signal levels of the other outputs. The driver outputs are protected against ESD to $\pm 10kV$ for human body model discharges.

REC1 IN, REC2 IN: Receiver Inputs. These pins accept RS232 level signals (\pm 30V) into a protected 5k terminating resistor. The receiver inputs are protected against ESD to \pm 10kV for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity. Open receiver inputs assume a logic low state.

REC1 OUT, REC2 OUT: Receiver outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in shutdown mode to allow data line sharing. Outputs are fully short-circuit protected to ground or V_{CC} with the power ON, OFF or in the shutdown mode.

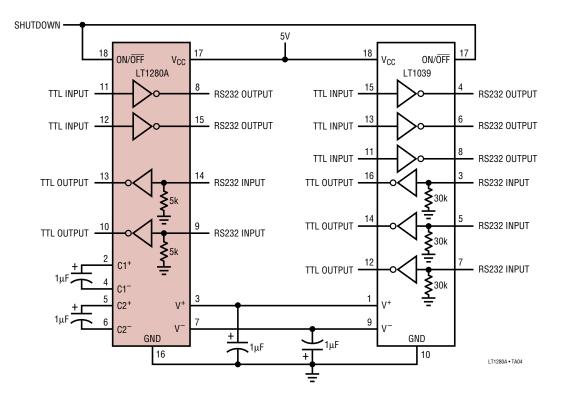
C1⁺, C1⁻, C2⁺, C2⁻: Commutating Capacitor Inputs. These pins require two external capacitors $C \ge 0.1 \mu$ F: one from C1⁺ to C1⁻ and another from C2⁺ to C2⁻. C1 should be deleted if a separate 12V supply is available and connected to pin C1⁺. Similarly, C2 should be deleted if a separate – 12V supply is connected to pin V⁻.



ESD PROTECTION

The RS232 line inputs of the LT1280A/LT1281A have onchip protection from ESD transients up to \pm 10kV. The protection structures act to divert the static discharge safely to system ground. In order for the ESD protection to function effectively, the power supply and ground pins of the circuit must be connected to ground through low impedances. The power supply decoupling capacitors and charge pump storage capacitors provide this low impedance in normal application of the circuit. The only constraint is that low ESR capacitors must be used for bypassing and charge storage. ESD testing must be done with pins V_{CC}, V_L, V⁺, V⁻, and GND shorted to ground or connected with low ESR capacitors.

TYPICAL APPLICATION



Supporting an LT1039 (Triple Driver/Receiver)

0.1µF

ESD Test Circuit 18 NC ON/OFF LT1280A 5V V_{CC} $C1^+$).1uF 0.1µF GND DR1 OUT 15 RS232 LINE PINS RX1 IN 14 PROTECTED TO ±10kV C2+ RX1 OUT 13 C2⁻ 0.1µF DR1 IN 12

DR2 IN

RX2 OUT

11

10

1280A ESD TC

DR2 OUT

9 RX2 IN

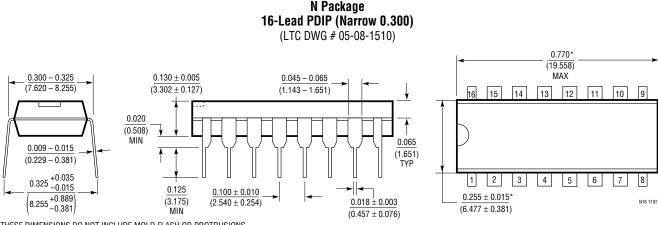
8

RS232 LINE PINS PROTECTED

TO ±10kV

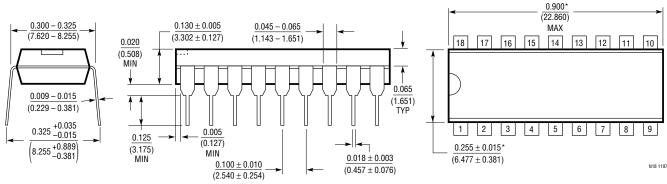


PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



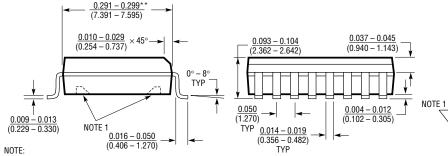
*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)

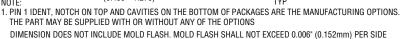
N Package 18-Lead PDIP (Narrow 0.300) (LTC DWG # 05-08-1510)



*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)







<u>0.398 - 0.413*</u> (10.109 - 10.490) 15 14 13 12 11 10 9 $\frac{0.394 - 0.419}{(10.007 - 10.643)}$ \Box \Box 2 3 4 5 6 7 8 S16 (WIDE) 0396

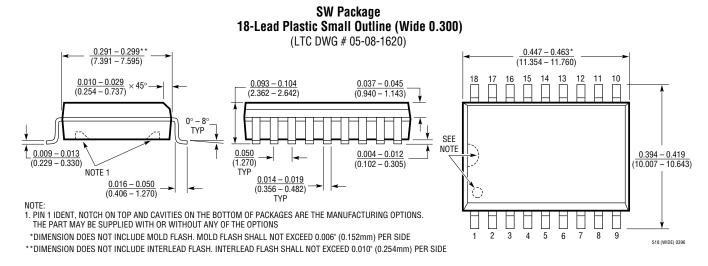
THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS

DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

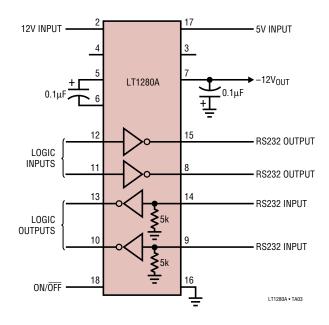


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PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



TYPICAL APPLICATION



Operation Using 5V and 12V Power Supplies

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1180A/LT1181A	5V 2-Driver/2-Receiver RS232 Transceivers	Pin Compatible with LT1280A/LT1280A
LT1381	5V 2-Driver/2-Receiver RS232 Transceiver	Narrow 16-Pin SO Package
LT1780/LT1781	5V 2-Driver/2-Receiver RS232 Transceiver	IEC 1000-4-2 Level 4 Compliance